TRICOLENE HD16953

High Density Polyethylene

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APPLICATIONS

PRODUCT DESCRIPTION

PROCESSING METHODS

This type of HDPE is a copolymer of ethylene and 1-hexene with Narrow Unimodal MWD

Injection Molding	Excellent Impact Strength Good ESCR Good Stiffness		Industrial Pails Pail Lids
RESIN PROPERTIES	TEST METHOD	VALUES, ENGLISH UNITS	VALUES, INTERNATIONAL UNITS
Melt Flow Rate 2.16 kgf/190 °C MFR ₂ Density 23 °C Antioxidant Package	ASTM D1238 ASTM D1505 	6.6 g/10 min 0.953 g/cm ³ Yes	6.6 g/10 min 0.953 g/cm ³ Yes
MECHANICAL PROPERTIES *	TEST METHOD	VALUES, ENGLISH UNITS	VALUES, INTERNATIONAL UNITS
Tensile Strenght at Yield 2,0 in/min (50,8 mm/min), Type IV compression molded plaque	ASTM D638	4,100 psi	28 MPa
Tensile Elongation at Break 2,0 in/min (50,8 mm/min), Type IV compression molded plaque	ASTM D638	950 %	950 %
Flexural Modulus Secant at 1 % of Elongation - 0,051 in/min (1,3 mm/min)	ASTM D790A	185,000 psi	1,276 MPa
Shore Hardness Type D Durometer	ASTM D2240	62.0	62.0
OTHER PROPERTIES *	TEST METHOD	VALUES, ENGLISH UNITS	VALUES, INTERNATIONAL UNITS
Vicat Softennig Temperature - VST 10 N (1 kg), 50 °C/h	ASTM D1525	257 °F	125 °C
Environmental Stress Crack Resistance - ESCR Condition B: 100 % Idenal at 50 °C. E50	ASTM D1693	20 h	20 h

CHARACTERISTICS

REGULATORY COMPLIANCE

This resin complies with the following FDA regulation: 21 CFR 177.1520: Olefinic Polymers. This regulation describes polyolefin resins that can be used safely for food packaging and preservation at low temperatures and at ambient temperatures. This resin is not designed for use in medical applications and should not be used in such applications.



^{*}The data presented here is true and accurate to the best of our knowledge. Likewise, the values are nominal and should not be taken as minimum or maximum specifications.

No warranty, express or implied, is made regarding resin performance. The customer must validate these properties according to his own evaluations on his machine and in his laboratory.